

PRODUCT NUMBER

73347-Y04LF

PLATING ☐ ROHS COMPATIBLE, SEE NOTE 5

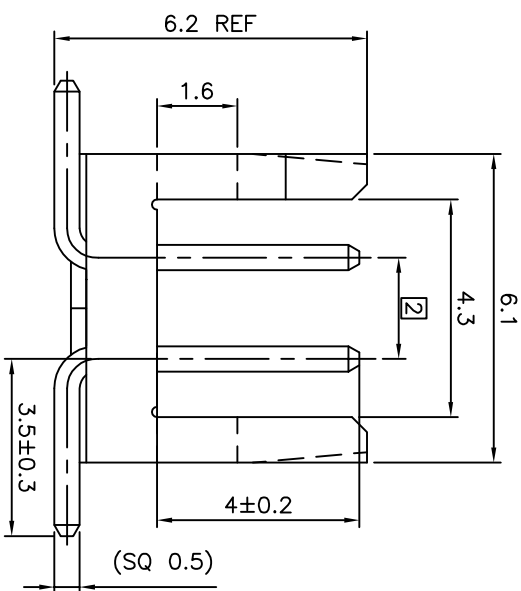
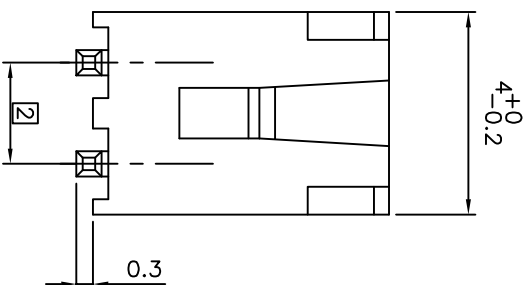
1XX = 0.76μm GOLD/GXT ON CONTACT AREA
2μm MIN MATT TIN ON TAIL

7XXLF = 0.76μm GOLD/GXT FULL PLATED
OVER 1.27μm Ni MIN

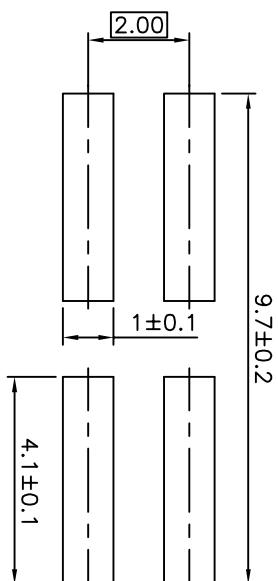
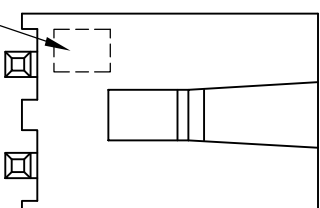
1.27 μ m MINIMUM NICKEL UNDERPLATE

NOTES :

1. MATERIAL HOUSING: HIGH TEMP. THERMOPLASTIC
UL 94V-0, COLOR CREAM
2. MATERIAL TERMINAL: COPPER ALLOY
3. 7N MIN. PIN RETENTION IN EITHER DIRECTION.
4. STANDARD PACKAGING IN POLYBAGS:
5. ROHS COMPATIBLE PRODUCT SPECIFICATIONS
- d - PLATING:
 - "LF" MEANS THE PRODUCT IS LEAD-FREE,
2µm MINIMUM MATTE TIN OVER 1.27µm
MINIMUM NICKEL UNDERPLATE.
- b - MANUFACTURING PROCESS COMPATIBILITY
 - THE HOUSING WILL WITHSTAND EXPOSURE TO
260°C PEAK TEMPERATURE FOR 30 SECONDS
MAX IN A CONVECTION, INFRA-RED OR VAPOR
PHASE OR REFLOW OVEN.
- c - LABELLING:
 - MEETS PACKAGING SPECS AS PER GS-14-920
- d - THIS PRODUCT MEETS EUROPEAN DIRECTIVES
AND OTHER COUNTRY REGULATIONS AS DISCRIBED
IN GS-47-0004.
6. PIN POS 1 RECOMMENDED ON THIS SIDE TO MATCH WITH
HOUSING CODING.



NOTE 6-



RECOMMENDED PAD LAYOUT

mat'l. code		surface		tolerance		projection		product family	
SEE NOTES		ISO 1302		✓ ISO 406 150		100		MINITEK HEADER	
lthr ecn no		dfr date		tolerances unless otherwise specified				title	
K B-19190		LMU 14.10.24		angles				MINITEK HEADER 2x2	
E F06-0266		LMU 06.08.09		linear		scale 6:1		dwg no	
F F07-0191		JCO 07.09.05		J.COMPAIGNON				sheet 1 of 1	
G F08-0145		ELA 15.04.08		engr				73347	
H F11-0078		LMU 11.06.29		chr				A3	
J F12-0018		JCO 12.02.27		dppd		JMC		96.03.20	
sheet revision								type	
index sheet								CUSTOMER Drawing	